

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Gotkis et al.

Application No: 09/821,415

Filed: March 28, 2001

For: SEMICONDUCTOR STRUCTURE IMPLEMENTING
LOW-K DIELECTRIC MATERIALS AND SUPPORTING
STUBS (As Amended)

Attorney Docket No: LAM2P246

Examiner: H.K. Vu

Group Art Unit: 2811

Date: July 24, 2002

COPY OF PAPERS
ORIGINALLY FILED

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail to: Commissioner for Patents, Washington, DC 20231 on July 24, 2002.

Signed

Courtney F. Yadegar

Commissioner for Patents
Washington, DC 20231

Sir:

Transmitted herewith are the Amendment and Marked-Up Title and Claims document in the above-identified application.

The fee has been calculated as shown below.

	Claims Remaining After Amendment	Highest Previously Paid For	Present Extra	SMALL ENTITY RATE FEE	OR	LARGE ENTITY RATE FEE
TOTAL CLAIMS	09 -	20	00	X09 = \$	OR	X18 = \$
INDEP CLAIMS	03 -	04	00	X42 = \$	OR	X84 = \$

[] Multiple Dependent Claim Present
and Fee Not Previously Paid

\$140

\$280

TOTAL

\$

\$

- ☐ Applicant(s) hereby petition for a _____ month(s) extension of time to respond to the outstanding Office Action.
- ☒ Applicant(s) believe that no (additional) Extension of Time is required; however, if it is determined that such an extension is required, Applicant(s) hereby petition that such an extension be granted and authorize the Commissioner to charge the required fees for an Extension of Time under 37 CFR 1.136 to Deposit Account No. 50-0805.
- ☐ Enclosed is our Check No. _____ in the amount of \$ _____ to cover the additional claim fee and/or extension of time fees.
- ☒ If the required fees are missing or any additional fees are required to facilitate filing the enclosed response, please charge such fees or credit any overpayment to Deposit Account No. 50-0805 (Order No. LAM2P246). A copy of this sheet is enclosed.

Respectfully submitted,
MARTINE & PENILLA, LLP
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TECHNOLOGY CENTER 2800

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

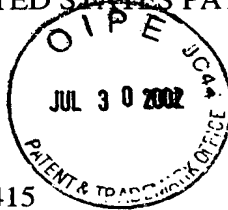
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Amended
F. JONES
8-8-02

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Signed:

Courtney F. Yadegar

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AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

This is in response to the Office Action, dated April 24, 2002. Please enter the following amendments and remarks:

IN THE TITLE

Please amend the Title to state:

"Semiconductor Structure Implementing Low-K Dielectric Materials and Supporting Stubs"

IN THE DRAWINGS

New Figure 1F-3 is submitted herewith having the requested changes in red ink.

IN THE CLAIMS

Please amend the claims as follows. All pending claims after this Amendment are in clean form and are listed below for the convenience of the Examiner. Attached hereto as a separate document is the "Marked-Up Title and Claims," showing amendments using bracketing and underlining.